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### Trench gate field-stop IGBT, HB series 650 V, 40 A high speed

Datasheet - production data

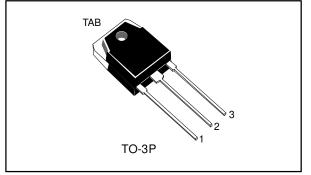
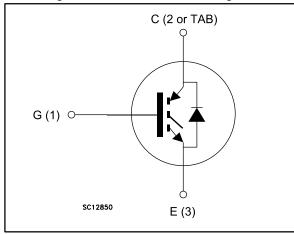


Figure 1: Internal schematic diagram



#### **Features**

- Maximum junction temperature: T<sub>J</sub> = 175 °C
- Minimized tail current
- V<sub>CE(sat)</sub> = 1.6 V (typ.) @ I<sub>C</sub> = 40 A
- Tight parameter distribution
- Co-packed diode for protection
- Safe paralleling
- Low thermal resistance

### **Applications**

• Power factor corrector (PFC)

### Description

This device is an IGBT developed using an advanced proprietary trench gate field-stop structure. The device is part of the new HB series of IGBTs, which represents an optimum compromise between conduction and switching loss to maximize the efficiency of any frequency converter. Furthermore, the slightly positive  $V_{CE(sat)}$  temperature coefficient and very tight parameter distribution result in safer paralleling operation.

#### Table 1: Device summary

Order code	Marking	Package	Packing
STGWT40HP65FB	GWT40HP65FB	TO-3P	Tube

This is information on a product in full production.

#### Contents

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### 1 Electrical ratings

Table 2: Absolute maximum ratings

Symbol	Parameter	Value	Unit
VCES	Collector-emitter voltage (V <sub>GE</sub> = 0 V)	650	V
	Continuous collector current at $T_c = 25 \text{ °C}$		٨
lc	Continuous collector current at Tc = 100 °C	40	A
ICP <sup>(1)</sup>	Pulsed collector current	160	А
$V_{\text{GE}}$	Gate-emitter voltage	± 30	V
F <sup>(2)</sup>	Continuous forward current at $T_C = 25 \ ^\circ C$	5	А
IF <sup>1-7</sup>	Continuous forward current at T <sub>C</sub> = 100 °C	5	A
IFP <sup>(3)</sup>	Pulsed forward current	10	А
Ртот	Total dissipation at $T_c = 25 \text{ °C}$ 283		W
Tstg	Storage temperature range - 55 to 150		°C
TJ	Operating junction temperature range	- 55 to 175	C

#### Notes:

 $\ensuremath{^{(1)}}\ensuremath{\mathsf{Pulse}}$  width limited by maximum junction temperature.

<sup>(2)</sup>Limited by wires.

<sup>(3)</sup>Pulsed forward current.

#### Table 3: Thermal data

Symbol	Parameter	Value	Unit
RthJC	Thermal resistance junction-case IGBT	0.53	
R <sub>thJC</sub>	Thermal resistance junction-case diode		°C/W
RthJA	Thermal resistance junction-ambient 5		



### 2 Electrical characteristics

 $T_{\rm J}$  = 25 °C unless otherwise specified

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
$V_{(BR)CES}$	Collector-emitter breakdown voltage	$V_{GE}$ = 0 V, I <sub>C</sub> = 2 mA	650			V
		$V_{GE} = 15 \text{ V}, I_{C} = 40 \text{ A}$		1.6	2.0	
V <sub>CE(sat)</sub> Collector-emitter satu voltage	Collector-emitter saturation	V <sub>GE</sub> = 15 V, I <sub>C</sub> = 40 A, T <sub>J</sub> = 125 °C		1.7		v
	Voltage	$V_{GE} = 15 \text{ V}, \text{ I}_{C} = 40 \text{ A},$ T <sub>J</sub> = 175 °C		1.8		
		I⊧ = 5 A		2		
VF	Forward on-voltage	I <sub>F</sub> = 5 A, T <sub>J</sub> = 125 °C		1.85		V
		I <sub>F</sub> = 5 A, T <sub>J</sub> = 175 °C		1.75		
$V_{\text{GE(th)}}$	Gate threshold voltage	$V_{CE}=V_{GE},\ I_{C}=1\ mA$	5	6	7	V
I <sub>CES</sub>	Collector cut-off current	$V_{GE} = 0 V, V_{CE} = 650 V$			25	μA
I <sub>GES</sub>	Gate-emitter leakage current	$V_{CE}=0~V,~V_{GE}=\pm20~V$			±250	nA

#### Table 4: Static characteristics

#### Table 5: Dynamic characteristics

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
Cies	Input capacitance		-	5412	-	
Coes	Output capacitance	V <sub>CE</sub> = 25 V, f = 1 MHz, V <sub>GE</sub> = 0 V	-	198	-	pF
Cres	Reverse transfer capacitance		-	107	-	
Qg	Total gate charge	Vcc = 520 V, Ic = 40 A,	-	210	-	
Q <sub>ge</sub>	Gate-emitter charge	e V <sub>GE</sub> = 15 V (see <i>Figure 29:</i>		39	-	nC
Qgc	Gate-collector charge	"Gate charge test circuit")	-	82	-	

#### Table 6: IGBT switching characteristics (inductive load)

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
td(off)	Turn-off-delay time	$V_{CE} = 400 \text{ V}, \text{ Ic} = 40 \text{ A},$	-	142	-	ns
t <sub>f</sub>	Current fall time	$V_{GE} = 15 \text{ V}, \text{ R}_{G} = 5 \Omega \text{ (see}$ Figure 28: "Test circuit for		27	-	ns
E <sub>off</sub> <sup>(1)</sup>	Turn-off switching energy	inductive load switching")	-	363	-	μJ
t <sub>d(off)</sub>	Turn-off-delay time	$V_{CE} = 400 \text{ V}, I_{C} = 40 \text{ A},$	-	141	-	ns
tr	Current fall time	urrent fall time $V_{GE} = 15 \text{ V}, \text{ R}_{G} = 5 \Omega$ $T_{J} = 175 \text{ °C}$ (see <i>Figure 28</i> :		61	-	ns
Eoff	Turn-off switching energy	"Test circuit for inductive load switching")	-	764	-	μJ

#### Notes:

 $^{(1)}\mbox{Including the tail of the collector current.}$ 

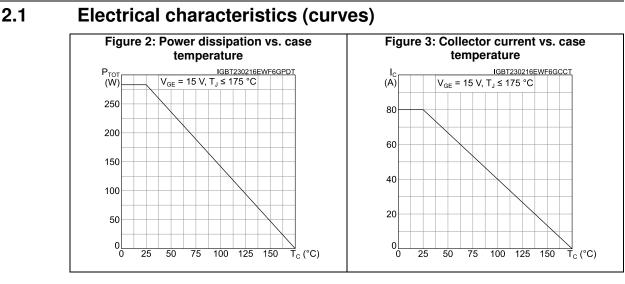


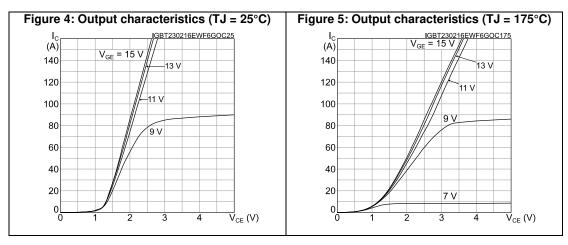
#### Electrical characteristics

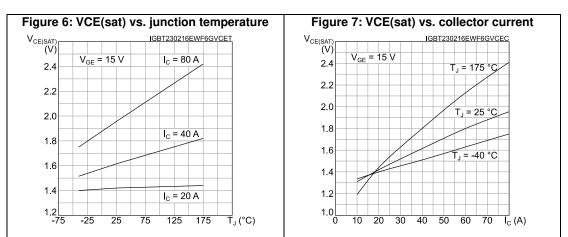
	Table 7: Diode switching characteristics (inductive load)					
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
trr	Reverse recovery time		-	140		ns
Qrr	Reverse recovery charge	$I_F = 5 A, V_R = 400 V,$	-	21		nC
Irrm	Reverse recovery current	V <sub>GE</sub> = 15 V (see <i>Figure</i> 28: "Test circuit for	-	6.6		А
dl <sub>rr</sub> /dt	Peak rate of fall of reverse recovery current during tb	verse inductive load switching")		430		A∕µs
Err	Reverse recovery energy		-	1.6		μJ
trr	Reverse recovery time		-	200		ns
Qrr	Reverse recovery charge	I <sub>F</sub> = 5 A, V <sub>R</sub> = 400 V, V <sub>GE</sub> = 15 V T <sub>J</sub> = 175 °C	-	47.3		nC
Irrm	Reverse recovery current	(see Figure 28: "Test	-	9.6		А
dl <sub>rr</sub> /dt	Peak rate of fall of reverse recovery current during $t_b$ circuit for inductive load switching") di/dt = 1000 A/µs		-	428		A∕µs
Err	Reverse recovery energy	$u/ut = 1000 A/\mu s$	-	3.2		μJ



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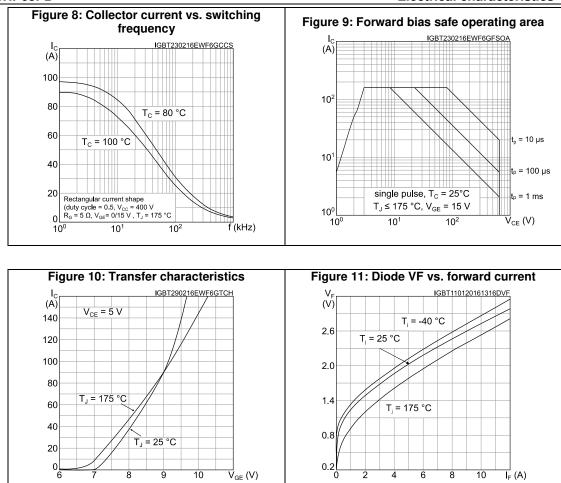


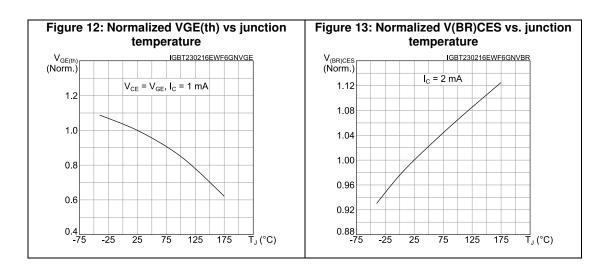






**Electrical characteristics** 



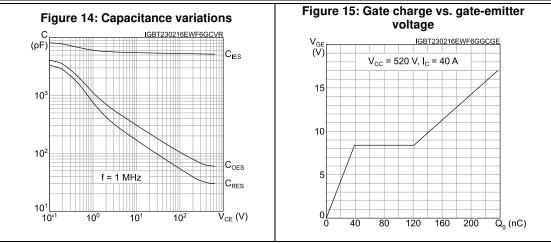


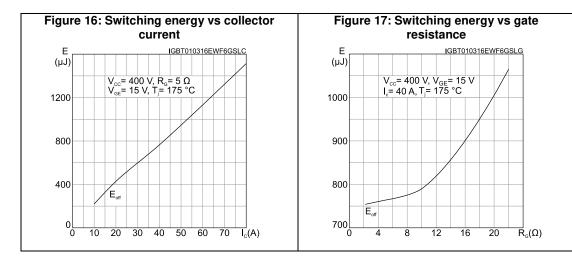
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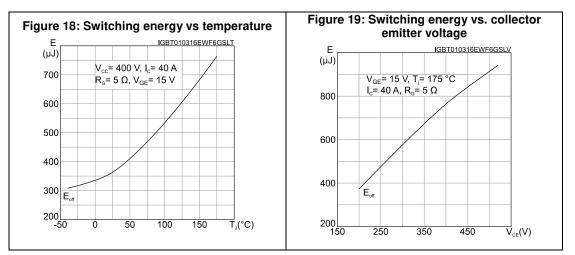
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#### **Electrical characteristics**

#### STGWT40HP65FB





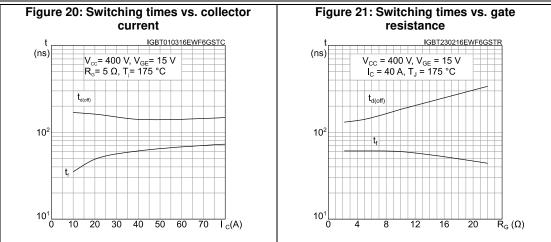


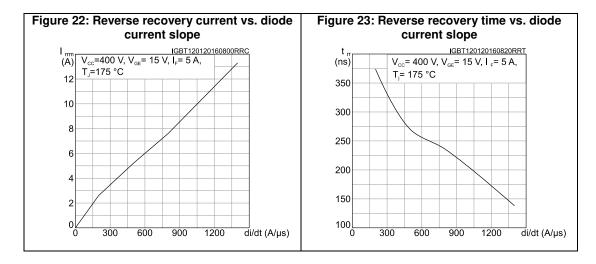
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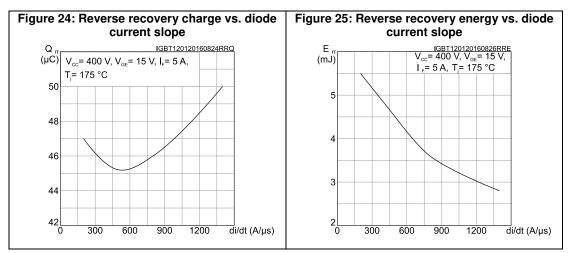


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**Electrical characteristics** 



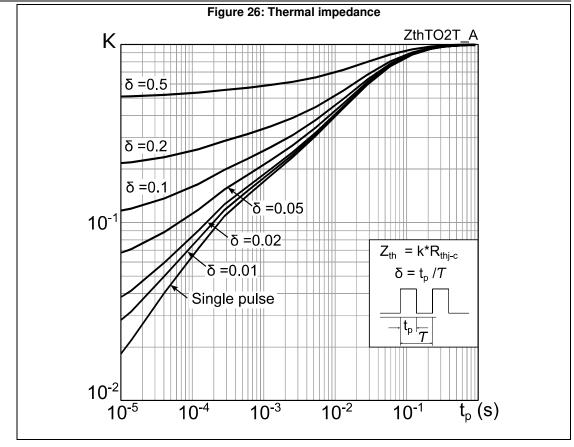




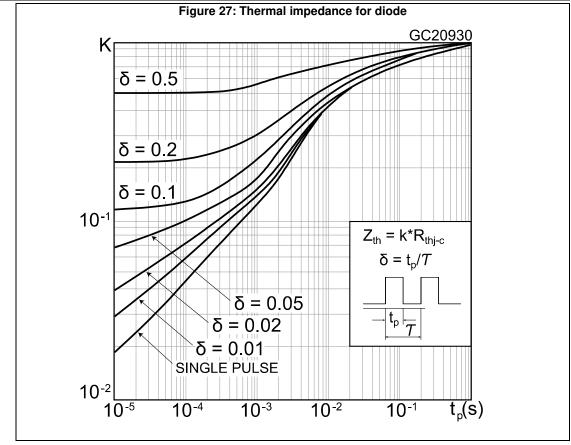
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#### **Electrical characteristics**

#### STGWT40HP65FB

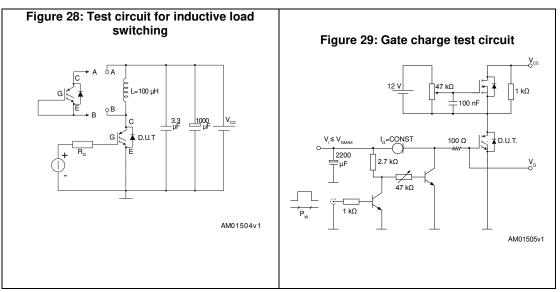


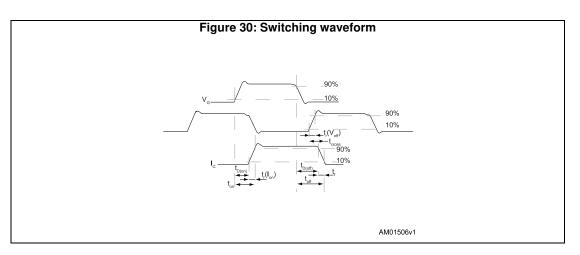
#### **Electrical characteristics**





### 3 Test circuits







### 4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK<sup>®</sup> packages, depending on their level of environmental compliance. ECOPACK<sup>®</sup> specifications, grade definitions and product status are available at: *www.st.com*. ECOPACK<sup>®</sup> is an ST trademark.



Package information

4.1 TO-3P package information

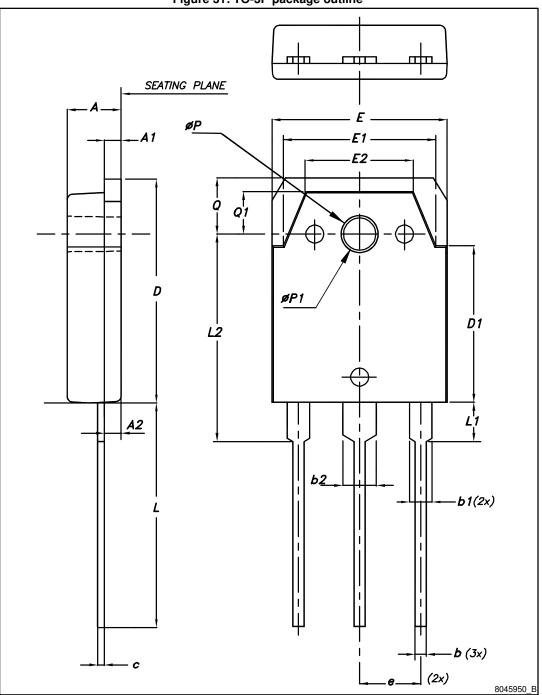


Figure 31: TO-3P package outline



#### Package information

HP65FB			Package information			
Table 8: TO-3P package mechanical data						
Dim.		mm				
Dim.	Min.	Тур.	Max.			
A	4.60	4.80	5.00			
A1	1.45	1.50	1.65			
A2	1.20	1.40	1.60			
b	0.80	1.00	1.20			
b1	1.80	2.00	2.20			
b2	2.80	3.00	3.20			
С	0.55	0.60	0.75			
D	19.70	19.90	20.10			
D1	13.70	13.90	14.10			
E	15.40	15.60	15.80			
E1	13.40	13.60	13.80			
E2	9.40	9.60	9.90			
е	5.15	5.45	5.75			
L	19.80	20.00	20.20			
L1	3.30	3.50	3.70			
L2	18.20	18.40	18.60			
ØP	3.30	3.40	3.50			
ØP1	3.10	3.20	3.30			
Q	4.80	5.00	5.20			
Q1	3.60	3.80	4			



### 5 Revision history

Table 9: Document revision history

Date	Revision	Changes
20-Oct-2015	1	First release.
01-Mar-2016	2	Updated features in cover page. Inserted <i>Section 2.1: "Electrical characteristics (curves)"</i> . Minor text changes
13-Jul-2016	3	Document status promoted from preliminary to production data.



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